## INCREMENTAL ENCODER COUNTER

## DESCRIPTION

The $\mu$ PD4701A is a counter for an X, Y 2-axis incremental encoder. When a two-phase encoder signal is input for the X and Y axes, direction discrimination and computation is performed, and count data is output in 8-bit parallel form. In addition, a 3-contact-point input buffer is incorporated, which is useful for applications which use a pointing device such as a mouse or track-ball. The CPU checks the switch input flag or count flag and reads the 12-bit count data in two operations, one for the lower byte and one for the upper byte. The key input flag is output together with the count data in the upper byte.

## FEATURES

- X, Y 2-axis incremental encoder counter
- Counter input (Schmitt-triggered input)
$\left.\begin{array}{l}X \text { axis: } X_{A}, X_{B} \text { 2-phase signal } \\ Y \text { axis: } Y_{A}, Y_{B} \text { 2-phase signal }\end{array}\right\}$ 4-multiplication count method used
- Counters: 12-bit binary up/down counters (2 sets, X \& Y)

Reset value: 000 H

- Count data output: 8-bit parallel latch output $\times 2$ (including key input flag)
- On-chip 3-contact-point key input buffer circuit
- CMOS
- Single +5 V power supply


## PIN NAMES



PIN CONFIGURATION (Top View)


## ORDERING INFORMATION

| Part Number | Package |
| :--- | :--- |
| $\mu$ PD4701AC | 24-pin plastic DIP (600 mil) |
| $\mu$ PD4701AGT | 24-pin plastic SOP (375 mil) |

## BLOCK DIAGRAM



## DATA MULTIPLEXER/LATCH BLOCK



## PIN FUNCTIONS

|  | Pin Name | Input/Output | Function |
| :---: | :---: | :---: | :---: |
| CPU interface block | $\overline{\mathrm{CS}}$ | Input | Chip Select input. "L" input activates outputs D0 to 7. <br> " H " input sets outputs D0 to 7 to high impedance. <br> Output data is latched on the fall edge of $\overline{C S}$. " $L$ " must be maintained during a count data read. |
|  | $\overline{\mathrm{X}} / \mathrm{Y}$ | Input | Counter Select input. "L" input selects the X counter, and " H " input selects the Y counter. |
|  | U/L | Input | Byte Select input. "L" input selects the lower byte and "H" input selects the upper byte, controlling data output. |
|  | RESET X RESET Y | Input | Counter reset inputs. RESET X input resets the X counter, and RESET Y input resets the Y counter. Both are active-" H ". |
|  | Doto 7 | $\begin{aligned} & \text { Output } \\ & \text { (3-state) } \end{aligned}$ | Bus for data output to the CPU. Outputs the byte data selected by the $\bar{X} / Y$ and U/L inputs. <br> The data latched on the fall of $\overline{\mathrm{CS}}$ is output. |
|  | $\overline{\mathrm{CF}}$ | Output | Counter flag output. Set (= "L" output) when the $X$ or $Y$ counter changes while $\overline{\mathrm{CS}}=$ "H". Reset ( $=$ "H" output) on the fall of $\overline{\mathrm{CS}}$. While $\overline{\mathrm{CS}}=$ "L", count flag output is disabled and the " H " level is output. |
|  | $\overline{\mathrm{SF}}$ | Output | Switch flag output. Becomes active (= "L" output) when the $\overline{\mathrm{RIGHT}}$, $\overline{\mathrm{LEFT}}$ or $\overline{\text { MIDDLE }}$ switch input is " $L$ ". |
| Mouse interface block | $\chi_{\text {A }}, \mathrm{X}_{\text {B }}$ | Input <br> (Schmitt input) | X counter 2-phase signal input pins |
|  | $Y_{A}, Y_{B}$ | Input <br> (Schmitt input) | Y counter 2-phase signal input pins |
|  | $\frac{\overline{\mathrm{RIGHT}}}{\frac{\mathrm{LEFT}}{\text { MIDDLE }}}$ | Input <br> (Schmitt input) | Key switch input pins. Key switch input are read as the high-order 4 bits of the $X$ counter and $Y$ counter upper byte as the internal status. <br> Upper Byte |
| Power supply block | VDD |  | +5 V power supply connection pin |
|  | Vss |  | Ground pin |

## DESCRIPTION OF OPERATIONS

## 1. COUNT OPERATION

The $\mu$ PD4701A executes an up-count and down-count by means of $A \& B 2$-phase signals in the 12-bit up-down counter. An up-count is performed when the A-phase signals $\left(X_{A}, Y_{A}\right)$ are phase-advanced, and a down-count is performed when the B-phase signals ( $Х_{в}, Y_{в}$ ) are phase-advanced. The edge of each signal is a count source. (4multiplication count method: see Fig. 1.)

Fig. 1 Count Operation Timing Chart


This count operation is executed independently for the $X$ axis $\left(X_{A}, X_{B}\right)$ and $Y$ axis $\left(Y_{A}, Y_{B}\right)$. This operation is initialized by reset input (RESET X, RESET Y) only.

In an up-count, the next value after FFFH is 000 H , and in a down-count, the next value after 000 H is FFFH.

## 2. OPERATION OF COUNT FLAG, $\overline{\mathrm{CF}}$

The count flag, $\overline{\mathrm{CF}}$, indicates that a count source (either $\mathrm{X}_{A, B}$ or $\mathrm{Y}_{A, B}$ edge input) has occurred while the $\overline{\mathrm{CS}}$ signal is " H ", and is an active-low output. $\overline{\mathrm{CF}}$ is reset ( $\rightarrow$ " H ") by $\overline{\mathrm{CS}}$ signal " $L$ " input. While $\overline{\mathrm{CS}}=$ " L ", count flag output is disabled and the " H " level is output.

Fig. 2 Count Flag Output Timing Chart


## 3. SWITCH INPUT OPERATION

The $\mu$ PD4701A can process up to 3 contact points as switch inputs (active-"L" input). Switch input is read as part of the count data upper byte together with the switch flag status as an internal status (see Fig. 3). These are all active"H" outputs. The switch flag status, SF, is equivalent to the switch flag output, $\overline{\mathrm{SF}}$, described below.

Fig. 3 Data Output Format

|  | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Upper Byte | SF | L | R | M | $\mathrm{C}_{11}$ | $\mathrm{C}_{10}$ | C9 | $\mathrm{C}_{8}$ |
| Bit No. | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Lower Byte | $\mathrm{C}_{7}$ | $\mathrm{C}_{6}$ | $\mathrm{C}_{5}$ | $\mathrm{C}_{4}$ | $\mathrm{C}_{3}$ | $\mathrm{C}_{2}$ | $\mathrm{C}_{1}$ | C0 |

SF: Switch Flag
L: Left Switch
R : Right Switch
M : Middle Switch
$\mathrm{C}_{11-0}$ : Count Data (12 bit)

## 4. OPERATION OF SWITCH FLAG, $\overline{\mathrm{SF}}$

The switch flag, $\overline{\mathrm{SF}}$, becomes active (active-"L" output) when the $\overline{\mathrm{RIGHT}}$, $\overline{\mathrm{LEFT}}$ or $\overline{\text { MIDDLE }}$ switch input is " L ". $\overline{\mathrm{SF}}$ can also be read as the switch flag status together with the count data.

## 5. DATA READ OPERATION

The CPU reads the count data and switch input status by controlling $\overline{C S}, \bar{X} / Y$ and $U / \bar{L}$. The relation between these is shown in Table 1. (At this time, the data latched on the falling edge of $\overline{C S}$ is output. If $\bar{X} / Y$ or $U / \bar{L}$ is switched while $\overline{\mathrm{CS}}$ is still " L ", the data at the point at which $\overline{\mathrm{CS}}$ changes from " H " to " L " is read. When $\overline{\mathrm{CS}}$ is set to " H ", new data is read into the latch, and the new data is confirmed on the next fall of CS.

Table 1 Data Output Table

| $\overline{\mathrm{CS}}$ | $\bar{X} / Y$ | U/L | D7 | D6 | D5 | $\mathrm{D}_{4}$ | $\mathrm{D}_{3}$ | $\mathrm{D}_{2}$ | $\mathrm{D}_{1}$ | Do |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | $\times \mathrm{C}_{7}$ | $\times \mathrm{C}_{6}$ | $\times \mathrm{C}_{5}$ | $\times \mathrm{C}_{4}$ | $\mathrm{xC}_{3}$ | $\mathrm{xC}_{2}$ | $\times \mathrm{C}_{1}$ | $\times \mathrm{C}_{0}$ |
| 0 | 0 | 1 | SF | L | R | M | $\times \mathrm{C}_{11}$ | $\mathrm{xC}_{10}$ | $\times \mathrm{C}_{9}$ | $\mathrm{xC}_{8}$ |
| 0 | 1 | 0 | $\mathrm{YC}_{7}$ | $\mathrm{rC}_{6}$ | $\mathrm{YC}_{5}$ | $\mathrm{rC}_{4}$ | $\mathrm{yC}_{3}$ | $\mathrm{rC}_{2}$ | $\mathrm{rC}_{1}$ | $\mathrm{rCO}_{0}$ |
| 0 | 1 | 1 | SF | L | R | M | $\mathrm{rC}_{11}$ | $\mathrm{rC}_{10}$ | $\mathrm{rC}_{9}$ | $\mathrm{rC}_{8}$ |
| 1 | $\times$ | $\times$ | FLOATING |  |  |  |  |  |  |  |

## 6. CONNECTION TO CPU SYSTEM

An example of connection to a CPU system is shown in Fig. 4.

Fig. 4 Example of Connection to CPU System


The above connections enable the CPU to read the X counter, Y counter and switch input status.

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

An example of a $\mu$ PD4701A data read is shown in Fig. 5.

Fig. 5 Example of $\mu$ PD4701A Data Read


* $\overline{\mathrm{CS}}$ must be kept at "0" during the read.


## 7. APPLICATION AREAS

Two-phase incremental signals are used for detection and measurement of a vector quantity (a quantity that has direction and magnitude), and are widely employed in measuring instruments such as micrometers and linear scales, control systems for digital servo motors, $X-Y$ tables, etc., head position control for printers, magnetic disks, etc., robot arm position control, and so on.

The $\mu$ PD4701A incorporates the direction judgment circuit and count pulse generator required for 2-phase incremental signal processing, up/down counters for counting these pulses, and a data latch to hold the read data, in IC form, enabling an X, Y 2-axis incremental signal processing system to be implemented easily.

In addition, a 3 switch-input buffer is incorporated, enabling this device to be widely used in man-machine interface and centronics interface application areas.

## 8. OPERATING PRECAUTIONS

1) As the $\mu$ PD4701A incorporates two sets of 12-bit counters, large transient currents flow during a count operation. Adecoupling capacitor of around $0.1 \mu \mathrm{~F}$ should therefore be inserted between Vod and Vss of the $\mu \mathrm{PD} 4701 \mathrm{~A}$.

2) If a pulse shorter than the signal phase difference time tsAB ( 350 ns ) is input to the $A / B$ phase inputs ( $X_{A}, X_{B}, Y_{A}$, $\left.Ү_{в}\right)$ this will result in a miscount. Therefore, if pulses shorter than tsAв are to be input because of encoder bounds, etc., a filter should be attached to the A/B phase inputs.


If $P W \geq$ tsAB ( 350 ns ), the count value remains the same before and after pulse input. (UP count $\rightarrow$ DOWN count or DOWN count $\rightarrow$ UP count is implemented, and therefore the result is equivalent to no change in the count value.

ABSOLUTE MAXIMUM RATINGS ( $\mathrm{Ta}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Vss $=0 \mathrm{~V}$ )

| PARAMETER | SYMBOL | RATING | UNIT |
| :--- | :---: | :---: | :---: |
| Supply voltage | $\mathrm{V}_{\text {DD }}$ | -0.5 to +7.0 | V |
| Input voltage | $\mathrm{V}_{1}$ | -1.0 to $\mathrm{VDD}_{\mathrm{DD}}+1.0$ | V |
| Output voltage | $\mathrm{Vo}_{0}$ | -0.5 to $\mathrm{VDD}_{\mathrm{DD}}+0.5$ | V |
| Operating temperature | $\mathrm{T}_{\text {opt }}$ | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $\mathrm{T}_{\text {stg }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Permissible loss | $\mathrm{PD}_{\mathrm{D}}$ | 500 | mW |

DC CHARACTERISTICS ( $\mathrm{Ta}=-40$ to $\left.+85^{\circ} \mathrm{C}, \mathrm{VDD}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%\right)$

| PARAMETER | SYMBOL | RATING |  | UNIT | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN. | MAX. |  |  |
| Input voltage high | VIL |  | 0.8 | V |  |
| Input voltage low | VIH | 2.6 |  | V | $X_{A}, X_{B}, Y_{A}, Y_{B}$ and $\overline{\text { LEFT }}, \overline{\text { RIGHT }}, \overline{\text { MIDDLE }}$ |
|  | $\mathrm{V}_{\mathrm{H}}$ | 2.2 |  | V | Other than the above |
| Output voltage low | Vol |  | 0.45 | V | $\mathrm{loL}=12 \mathrm{~mA}$ |
| Output voltage high | Vон | VDD - 0.8 |  | V | $\mathrm{IOH}=-4 \mathrm{~mA}$ |
| Static consumption current | IDD |  | 50 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{dD}}, \mathrm{V}_{\text {Ss }}$ |
| Input current | 11 | -1.0 | 1.0 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{dD}}, \mathrm{V}_{\text {ss }}$ |
| 3-state output leak current | loff | -10 | 10 | $\mu \mathrm{A}$ |  |
| Dynamic consumption current | IDD dyn |  | 2 | mA | $\mathrm{fin}=500 \mathrm{kHz}$ |
| Hysteresis voltage | $V_{H}$ | 0.25 |  | V | $X_{A}, X_{B}, Y_{A}, Y_{B}$ and $\overline{\text { LEFT }}, \overline{\text { RIGHT }}, \overline{\text { MIDDLE }}$ |

AC CHARACTERISTICS ( $\mathrm{Ta}_{\mathrm{a}}=\mathbf{- 4 0}$ to $+85^{\circ} \mathrm{C}, \mathrm{VDD}=+5 \mathrm{~V} \pm 10 \%$ )

| PARAMETER |  | SYMBOL | RATING |  | UNIT | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN. | MAX. |  |  |
| $\begin{aligned} & X_{A}, X_{B} \\ & Y_{A}, Y_{B} \end{aligned}$ | Input cycle |  | tcyab | 2 |  | $\mu \mathrm{s}$ | $\mathrm{fin}_{\text {i }}=500 \mathrm{kHz}$ |
|  | High-level pulse width | tpwab | 900 |  | ns |  |
|  | Low-level pulse width | tpwabl | 900 |  | ns |  |
|  | Signal phase difference time | tsab | 350 |  | ns |  |
| $\begin{gathered} \overline{\mathrm{R}}, \overline{\mathrm{~L}} \\ \overline{\mathrm{M}} \end{gathered}$ | High-level pulse width | tpwswh | 30 |  | $\mu \mathrm{s}$ | Switch OFF |
|  | Low-level pulse width | tpwswL | 30 |  | $\mu \mathrm{s}$ | Switch ON |
| $\overline{\mathrm{SF}}$ | Setting delay time | tDsFL |  | 50 | ns | Switch ON |
|  | Reset delay time | tDsFH |  | 50 | ns | Switch OFF |
| RESETW, Y | Pulse width | tpwrs | 100 |  | ns |  |
|  | Count enable time | tscten | 0 |  | ns | From RESET $x_{\text {, }} \mathrm{y} \downarrow$ |
|  | Count clear time | toctcl |  | 100 | ns | From RESET $\chi_{\text {, }} \mathrm{Y} \uparrow$ |
| $\overline{\mathrm{CF}}$ | Flag setting time | tdabcF |  | 120 | ns | From $X_{A}, \mathrm{~B}, \mathrm{Y}_{\mathrm{A}}, \mathrm{B}$ |
|  | Flag reset time | tocscF |  | 100 | ns | From $\overline{\mathrm{CS}} \downarrow$ |
|  | Count setting time | tsct | 0 |  | ns | From $\overline{\mathrm{CF}} \downarrow$ |
| $\overline{\mathrm{CS}}$ | $\overline{\mathrm{CF}}$ enable time | tscscF | 140 |  | ns | From $\overline{\mathrm{CF}} \downarrow$ |
|  | $\overline{\mathrm{CF}}$ disable time | thabcs | 140 |  | ns | From $X_{A}, \mathrm{~B}, \mathrm{Y}_{\mathrm{A}}, \mathrm{B}$ |
|  | Pulse width | tpwcs | 200 |  | ns |  |
| $\begin{aligned} & \bar{X} / Y \\ & U / \bar{L} \end{aligned}$ | Address setup time | tsacs | 0 |  | ns | To $\overline{\mathrm{CS}} \downarrow$ |
|  | Address hold time | thcsab | 0 |  | ns | From $\overline{\mathrm{CS}} \uparrow$ |
| Doto 7 | Output delay time | tocsd |  | 150 | ns | From $\overline{\mathrm{CS}} \downarrow$ |
|  | Output delay time | tdad |  | 100 | ns | From $\bar{X} / \mathrm{Y}, \mathrm{U} / \overline{\mathrm{L}}$ |
|  | Floating time | tfcsd |  | 50 | ns | From $\overline{\mathrm{CS}} \uparrow$ |

## AC TEST INPUT WAVEFORM



AC test: The input is driven by 2.6 V for logic " 1 ", and 0.45 V for logic " 0 ".
Timing measurement is performed at 1.5 V for both logic " 1 " and logic " 0 ".

Fig. 6 Two-Phase Signal \& Switch Signal Input Timing


Fig. 7 Count Flag Output Timing


Fig. 8 Data Output Timing


Fig. 9 Switch Flag Signal Output Timing


## RECOMMENDED SOLDERING CONDITIONS

The following conditions (see table below) must be met when soldering this product.
Please consult with our sales offices in case other soldering process is used, or in case soldering is done under different conditions.

## types of surface mount device

$\mu$ PD4701AGT

| Soldering process | Soldering conditions | Symbol |
| :--- | :--- | :---: |
| Infrared ray reflow | Peak package's surface temperature: $235^{\circ} \mathrm{C}$ or below, <br> Reflow time: 30 seconds or below $\left(210^{\circ} \mathrm{C}\right.$ or higher), <br> Number of reflow process: 2, Exposure limit*: None | IR35-00-2 |
| VPS | Peak package's surface temperature: $215^{\circ} \mathrm{C}$ or below, <br> Reflow time: 40 seconds or below ( $200^{\circ} \mathrm{C}$ or higher), <br> Number of reflow process: 2, Exposure limit*: None | VP15-00-2 |
| Wave soldering | Solder temperature: $260^{\circ} \mathrm{C}$ or below, <br> Flow time: 10 seconds or below, <br> Number of flow process: 1, Exposure limit*: None | WS60-00-1 |
| Partial heating method | Terminal temperature: $300{ }^{\circ} \mathrm{C}$ or below, <br> Flow time: 10 seconds or below, <br> Exposure limit*: None |  |

* Exposure limit before soldering after dry-pack package is opened.

Storage conditions: $25^{\circ} \mathrm{C}$ and relative humidity at $65 \%$ or less.

Note Do not apply more than a single process at once, except for "Partial heating method".

TYPE OF THROUGH HOLE MOUNT DEVICE
$\mu$ PD4701AC

| Soldering process | Soldering conditions | Symbol |
| :---: | :--- | :---: |
| Wave soldering | Solder temperature: $260^{\circ} \mathrm{C}$ or below, <br> Flow time: 10 seconds or below |  |

## 24PIN PLASTIC DIP (600 mil)



## NOTES

1) Each lead centerline is located within 0.25 mm ( 0.01 inch ) of its true position (T.P.) at maximum material condition.
2) Item " K " to center of leads when formed parallel.

| ITEM | MILLIMETERS | INCHES |
| :---: | :--- | :--- |
| A | 33.02 MAX. | 1.300 MAX. |
| B | 2.54 MAX. | 0.100 MAX. |
| C | 2.54 (T.P.) | 0.100 (T.P.) |
| D | $0.50 \pm 0.10$ | $0.020_{-0.005}^{+0.004}$ |
| F | 1.2 MIN. | 0.047 MIN. |
| G | $3.5 \pm 0.3$ | $0.138 \pm 0.012$ |
| H | 0.51 MIN. | 0.020 MIN. |
| I | 4.31 MAX. | 0.170 MAX. |
| J | 5.72 MAX. | 0.226 MAX. |
| K | 15.24 (T.P.) | 0.600 (T.P.) |
| L | 13.2 | 0.520 |
| M | $0.25_{-0}^{+0.10}$ | $0.010_{-0.004}^{+0.004}$ |
| N | 0.25 | 0.01 |
| R | $0 \sim 15^{\circ}$ | $0 \sim 15^{\circ}$ |
|  |  | P24C-100-600-1 |

## 24 PIN PLASTIC SOP (375 mil)


detail of lead end


## NOTE

Each lead centerline is located within 0.12 mm ( 0.005 inch) of its true position (T.P.) at maximum material condition.


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